ECE 340: Semiconductor Electronics

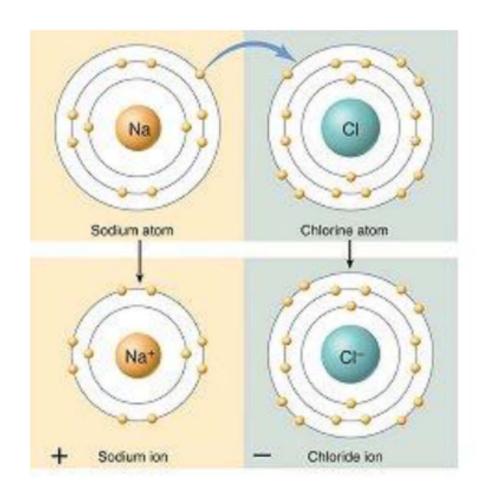
Chapter 3: Energy bands and charge carriers in semiconductors (part I)

Wenjuan Zhu



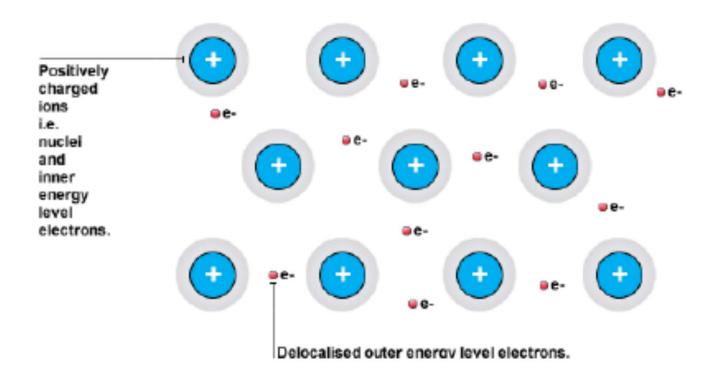
- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
 - Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass
 - Intrinsic material
 - Extrinsic material

Ionic bonding of NaCl (insulator)



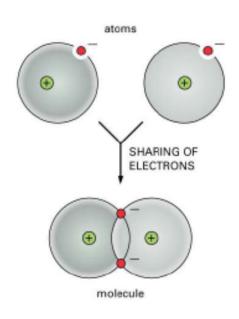


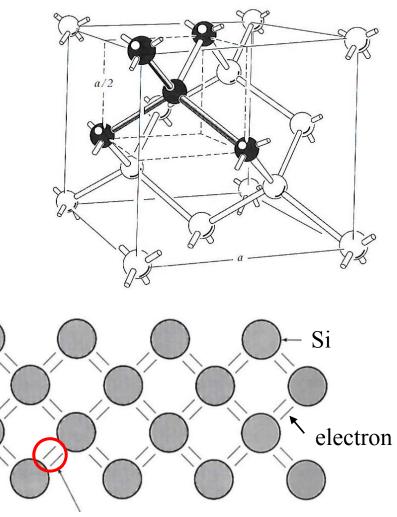
Metallic Bonding



- Outer shell is only partially filled.
- Screening by other charges makes the valence electron very loosely bound.
- Outer electron contributed to crystal as a whole.
- Bonding can be very complex depending on the compound involved.

Covalence bonding in silicon crystal





Two electrons per bond

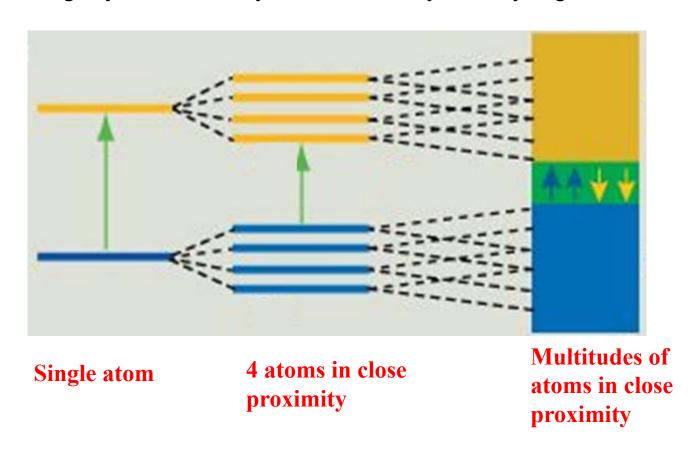
Bonding force and energy band



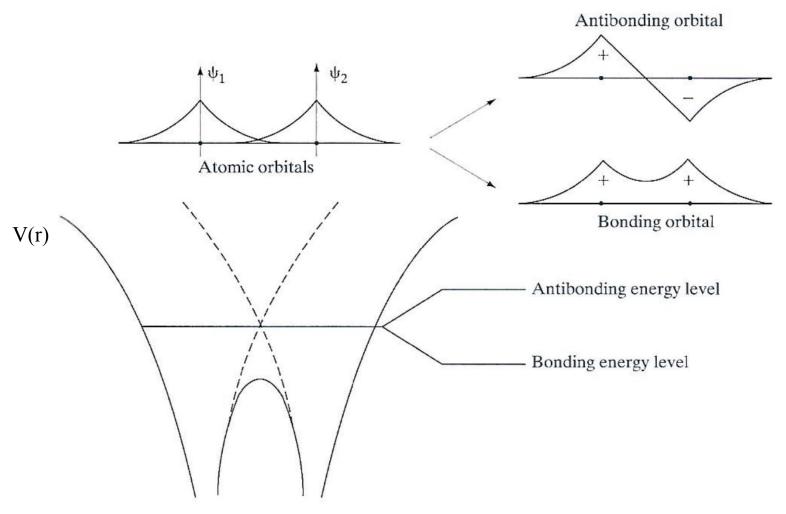
- Bonding forces in solids
- Energy bands
- Metals, semiconductors, and insulators
- Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass
 - Intrinsic material
 - Extrinsic material

Energy Levels vs Energy Bands

- Isolated atoms: no overlap of electronic wave functions, only has original discrete energy levels;
- Interacting atoms: overlaps of electronic wave functions, many new energy levels are created through hybridization. If you have too many levels, you get a band!

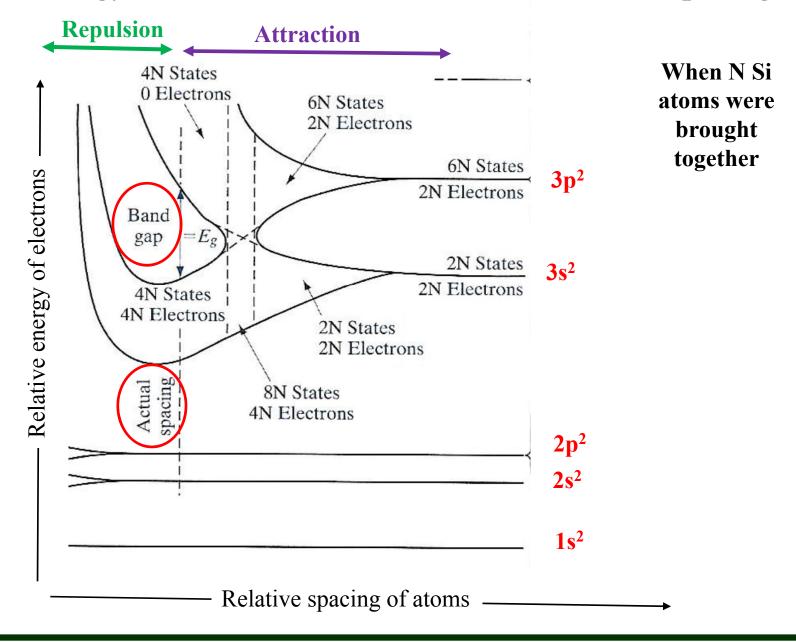


Bring two silicon atoms together

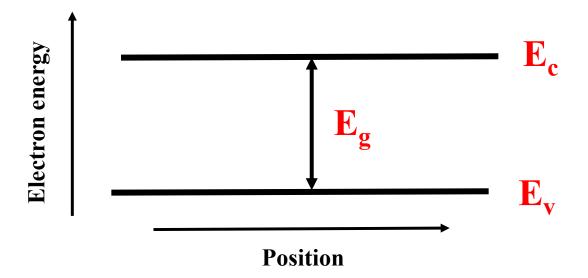


Leads to two distinct "normal" modes – a higher energy antibonding orbital and a lower energy bonding orbital. The electron probability density is higher in the region between the ion cores, leading to lowering of the bonding energy

Energy levels in Si as a function of interatomic spacing



Energy Band Diagram



Simplified version of energy band model, indicating:

- Bottom edge of the conduction band (E_c)
- Top edge of the valence band (E_v)

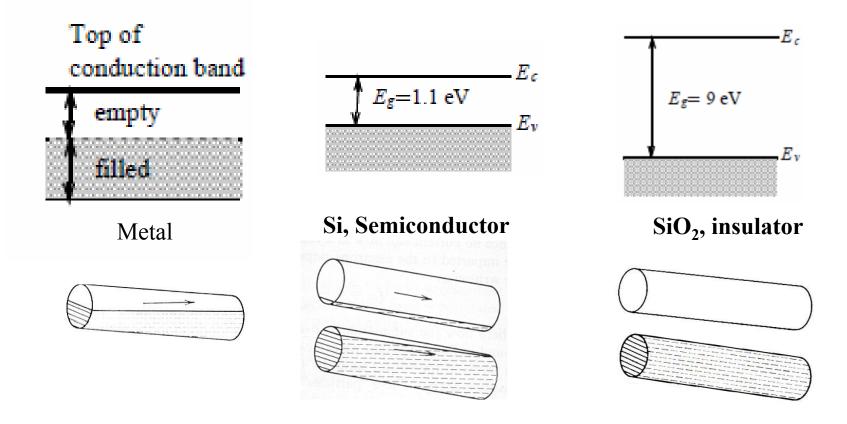
Ec and Ev are separated by the **band gap energy** E_g

- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands



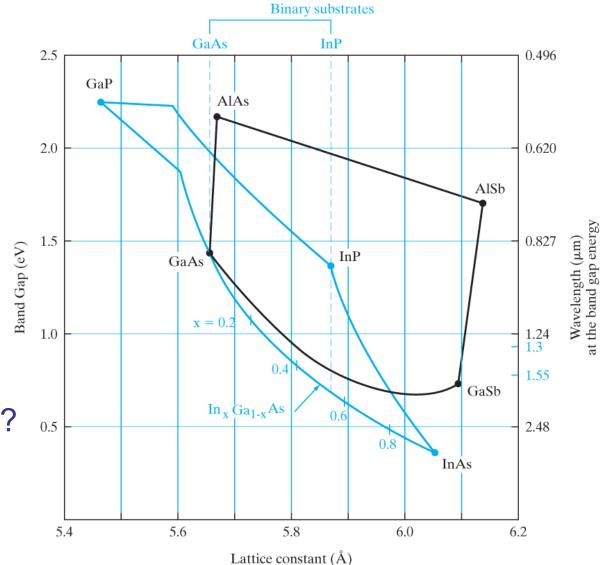
- Metals, semiconductors, and insulators
- Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass
 - Intrinsic material
 - Extrinsic material

Metal, semiconductor and insulator



- Band structure explains why SiO₂ (diamond, etc) is insulating, silicon is semiconducting, copper is a metal
- For electrons to be accelerated in an electric field they must be able to move into new, unoccupied energy states.

How do band gaps vary with lattice size? (is there a trend?)



How do band gaps
 vary with temperature?

- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
- Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass
 - Intrinsic material
 - Extrinsic material

E-k diagram

E: energy

k: wavevector, or propagation constant $k = 2\pi/\lambda$ momentum $p = \hbar k$

• For classic objects, the kinetic energy $E_{kE} = \frac{mV^2}{2} = \frac{P^2}{2m} = \frac{\hbar^2 k^2}{2m}$

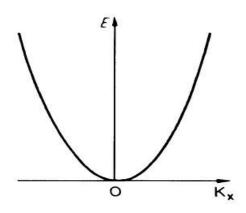
E~k curve (dispersion curve) is a "parabola".

• In quantum mechanics, free electron has the planewave wavefunction,

$$\psi_k(x) = e^{jk_x \cdot x}$$

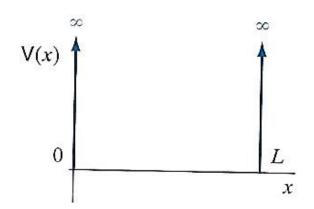
the E~k relationship is similar:

$$E = \frac{\hbar^2 k^2}{2m}$$



E-k diagram

For particle in a box:



$$-\frac{\hbar^2}{2m}\nabla^2\psi + V\psi = E\psi$$

$$\Longrightarrow \psi_n = \sqrt{\frac{2}{L}}\sin(kx)$$



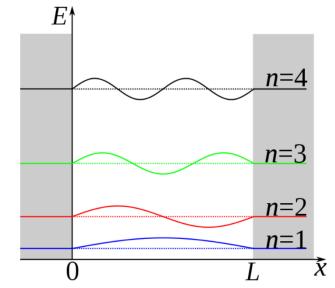
$$\psi_n = \sqrt{\frac{2}{L}}\sin(kx)$$

$$k = \frac{n\pi}{L}$$
, $n = 1,2,3,...$

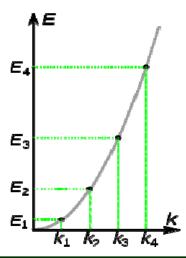
$$n = 1,2,3,...$$

$$E = \frac{n^2 \pi^2 \hbar^2}{2mL^2}, \qquad n = 1,2,3,...$$

$$n = 1,2,3,...$$



$$\implies E = \frac{\hbar^2 k^2}{2m}$$

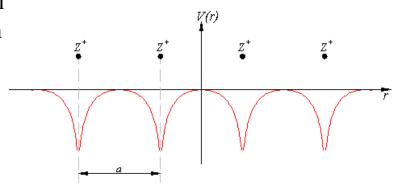


E~K relation in periodical lattice

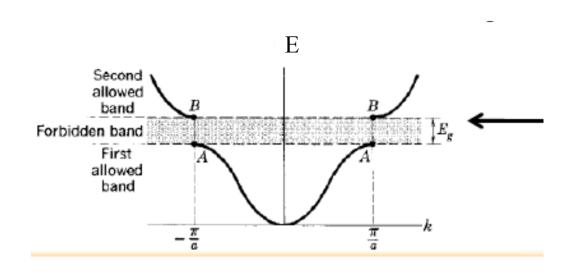
For electron in a periodic lattice, i.e a periodic Col potential, the solution of the Schrödinger equation wavefunction is in a form:

$$\psi_k(x) = U(k_x, x)e^{jk_x \cdot x}$$

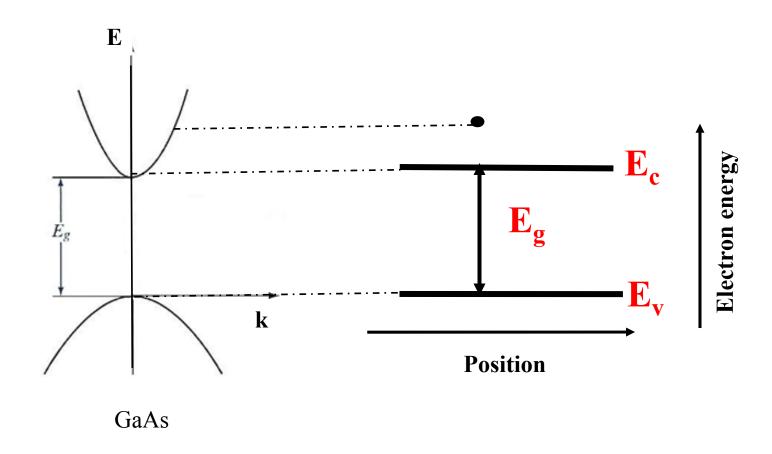
(called Bloch function).



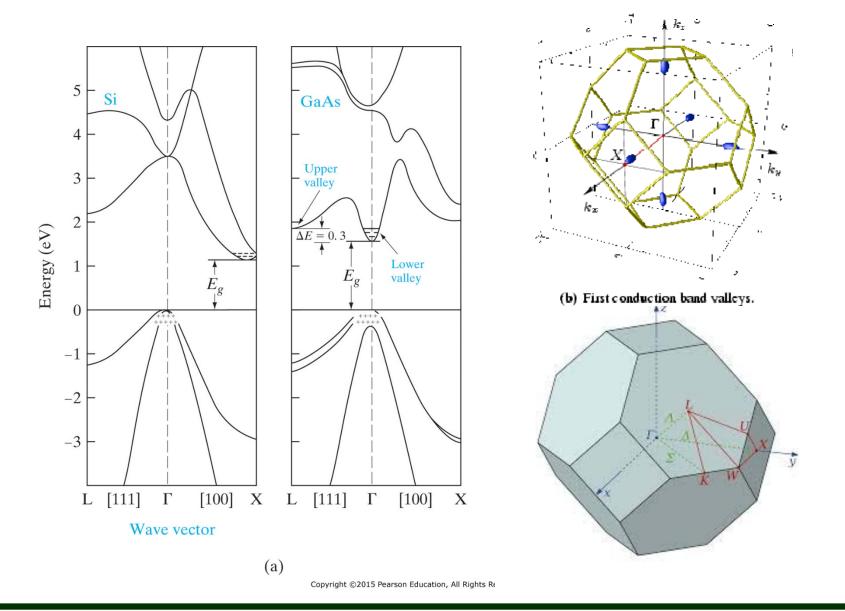
E~k relation is periodic with a bandgap. It is parabolic near the minimum or maximum of a band.



E-K vs. E-X



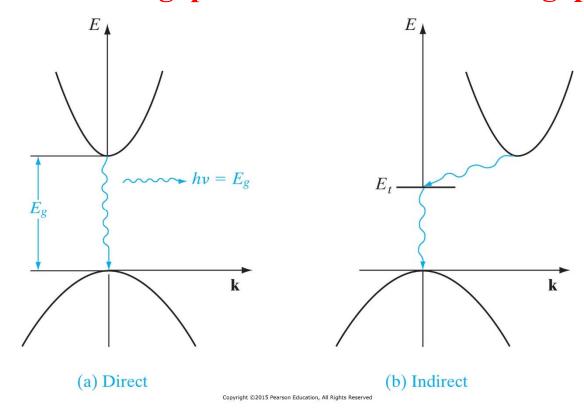
Band structures in semiconductors



Direct and indirect band gap

Direct band gap

Indirect band gap



Direct band gap: minimum in the conduction band and maximum of valence band occurs at the **same** k value.

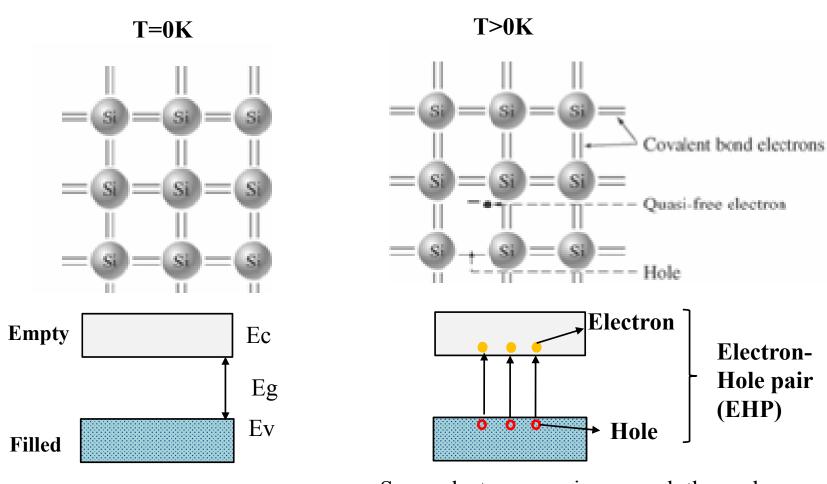
Indirect band gap: minimum in the conduction band and maximum of valence band occurs at the **different** k value

- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
 - Direct and indirect semiconductors
- Charge carriers in semiconductors



- Electrons and holes
- Effective mass
- Intrinsic material
- Extrinsic material

Electron and holes



Some electrons receive enough thermal energy to be excited from valence band to conduction band

No free electrons in

the semiconductor

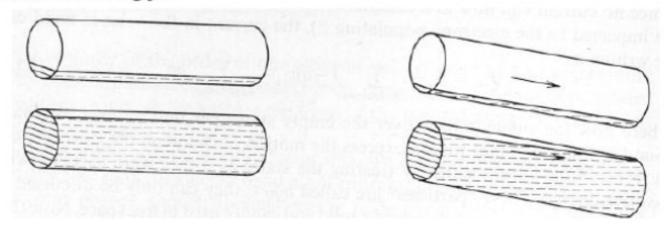
Electron-

Hole pair

(EHP)

Hole

- What is a hole?
 - An empty state in the valence band
 - Treated as a positive charge carrier in the semiconductor
 - · Fluid analogy:



- Pure silicon at room temperature,
 - electron-hole pair density: 10¹⁰ EHP/cm³
 - Silicon atom density: 5x10²² atom/cm³
 - → electrons in the conduction band are free to move via many available empty states.

 Let's combine energy bands vs. k and vs. x:

 Note what is potential, kinetic, and total energy

 Note which way energy of holes increases

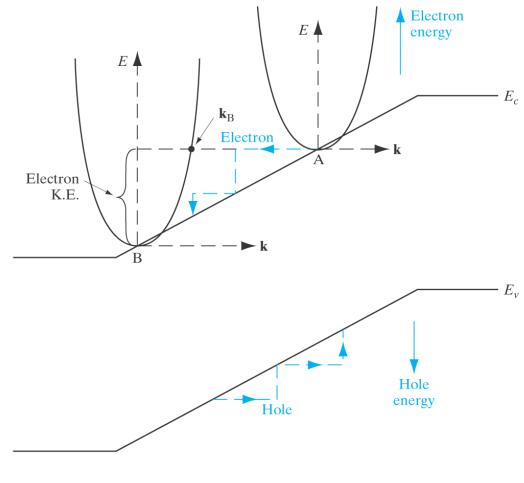


Figure 3.9

Superimposition of the (E,\mathbf{k}) band structure on the E-versus-position simplified band diagram for a semiconductor in an electric field. Electron energies increase going up, while hole energies increase going down. Similarly, electron and hole wave vectors point in opposite directions and these charge carriers move opposite to each other, as shown.

- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
 - Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes

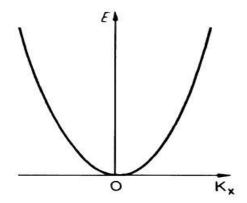


- Effective mass
- Intrinsic material
- Extrinsic material

Effective Mass

- The electron momentum is $P = mv = \hbar k$
- Free electron energy is:

$$E = \frac{mv^2}{2} = \frac{P^2}{2m} = \frac{\hbar^2 k^2}{2m}$$



 The electron mass is inversely related to the curvature of the (E,K) relationship:

$$\frac{d^2E}{dk^2} = \frac{\hbar^2}{m}$$

 Most energy band are close to parabolic at their minima (for conduction bands) or maxima (for valence bands), the effective mass of an electron in a band is:

$$m^* = \frac{\hbar^2}{(d^2E)/(dk^2)}$$

Thus the curvature of the band determines the electron effective mass

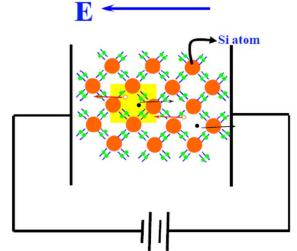
Effective Mass of electrons and holes

Newton's law:

$$Force = F_{int} + F_{ext} = ma$$

"true" mass, same as free electron mass m_0

 F_{int} is the collection of internal periodic crystal forces F_{ext} is the externally applied force



 If the effect of all the internal periodic crystal forces are considered and encapsulated into the band structure.
 Then electron then respond to external force with a new mass:

$$F_{ext} = m^*a$$

where m* is the "effective mass" of the particle, which includes all the complex influences of the crystal potential on the motion of the electron (or hole).

Effective Mass of electrons and holes

- Effective mass values? Fractions of m₀. See Appendix III.
 - Sometimes depend on direction of motion in the crystal.
 - E.g. for electrons in Si: $m_1 = 0.98m_0$, $m_t = 0.19m_0$
 - Can also depend on particle location in the band (bottom, top, edge, "light" band vs. "heavy" band).
 - Values in Appendix III are given at the bottom of C-band for electrons, top of V-band for holes.

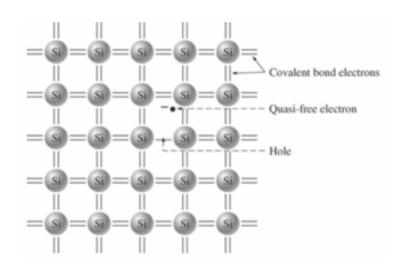
- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
 - Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass

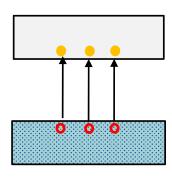


- Intrinsic material
- Extrinsic material

Intrinsic semiconductor

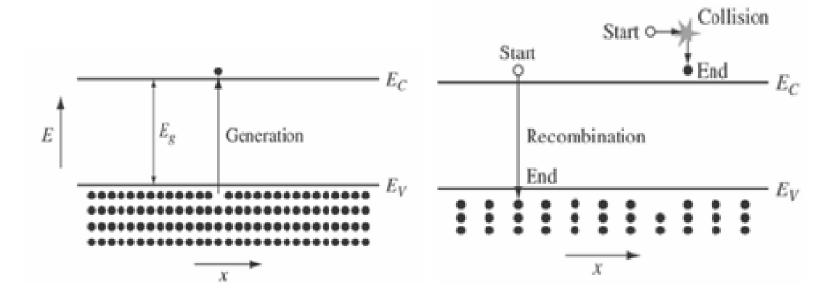
• <u>Intrinsic</u> semiconductor = pure, without external additives





- No free charge carriers at T=0K
- What about at T=300K?
- How much energy to break a bond?

Generation and recombination in intrinsic semiconductor



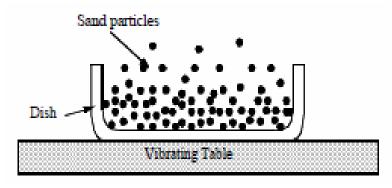
Electron and home generate in pairs and recombine in pairs.

$$n = p = n_i$$

n: electron concentration

p: hole concentration

n_i: intrinsic carrier concentration



Mechanical analogy:

Generation and recombination rate

- Generation rate of EHP g_i is determined by the temperature and bandgap:
 - High T → <u>higher or lower?</u> generation rate
 - Small band gap → <u>higher or lower?</u> generation rate
- Recombination rate is determined by the number of electron and hole concentration:

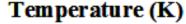
$$r_i = \alpha n_0 p_0 = \alpha n_i^2$$

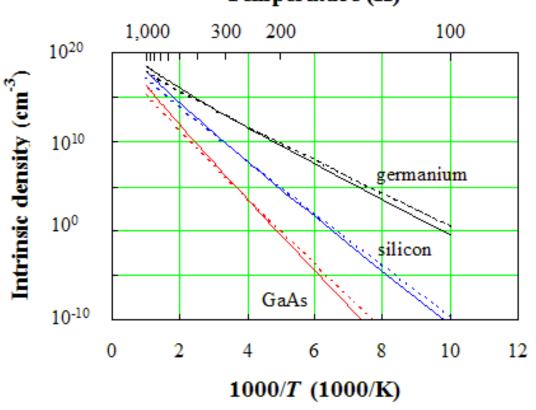
At equilibrium:

$$r_i = g_i = \alpha n_i^2$$

Question: How is the intrinsic carrier concentration change with temperature and band gap?

Intrinsic carrier concentration as a function of temperature

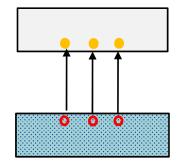




How does n_i change with T? Which curve is for GaAs, Si, Ge?

GaAs: $E_G \approx 1.42 \text{ eV}$ Si: $E_G \approx 1.12 \text{ eV}$

Ge: $E_G \approx 0.67 \text{ eV}$



© Bart Van Zeshbroeck 2007

Intrinsic carrier density versus temperature in gallium arsenide (GaAs), silicon and germanium. Compared is the calculated density with (solid lines) and without (dotted lines) the temperature dependence of the energy bandgap

For Silicon at room temperature, intrinsic carrier density $| \mathbf{n_i} \cong \mathbf{10^{10}} \ \mathbf{cm^{-3}}$

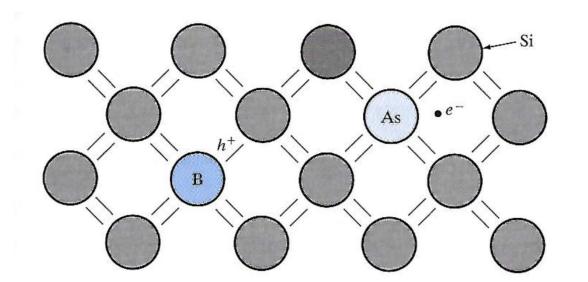
- Bonding force and energy band
 - Bonding forces in solids
 - Energy bands
 - Metals, semiconductors, and insulators
 - Direct and indirect semiconductors
- Charge carriers in semiconductors
 - Electrons and holes
 - Effective mass
 - Intrinsic material



Extrinsic material

Extrinsic material

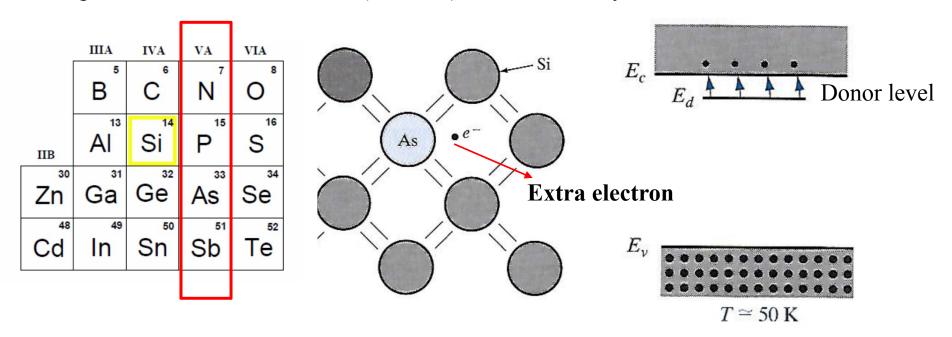
- How to manipulating the carrier concentration?
- Doping = purposely introducing impurities into the crystal
- *Intrinsic* material = pure, undoped. *Extrinsic* = doped.



		ША	IVA	VA	VIA
		5	6	7	8
		В	C	N	0
		13	14	15	16
III	3	ΑI	Si	Р	S
	30	31	32	33	34
Z	n	Ga	Ge	As	Se
	48	49	50	51	52
C	d	In	Sn	Sb	Те

N type doping

Example: Add column V elements (P, As etc) into Si or Ge crystal:



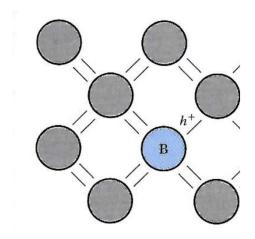
Electron concentration is much higher than holes

$$n_0 \gg p_0$$
 or n_i

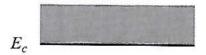
called **n** type material.

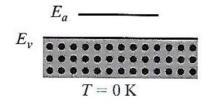
P type doping

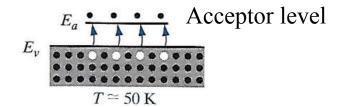
Example: adding column III element to Si or Ge crystal:

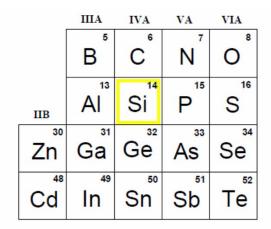












- The impurity introduce an energy level very near the valence band. This type of impurity level "accept" electron from valence band and are called "acceptor" impurity.
- Hole concentration is much higher than electrons

$$p \gg n_0 \text{ or } n_i$$

called **p** type material.

Binding energy

- Arsenic (As) dopant in Si: 4 electrons used up for bonding with neighbors. But, how loosely bound is that 5th electron that As brought into the Si lattice?
- Approximate binding energy using Niels Bohr's model:

$$E_B \approx \frac{m^* q^4}{2K^2\hbar^2}$$
 be careful with choice of m* and K = $4\pi\epsilon_r\epsilon_0$

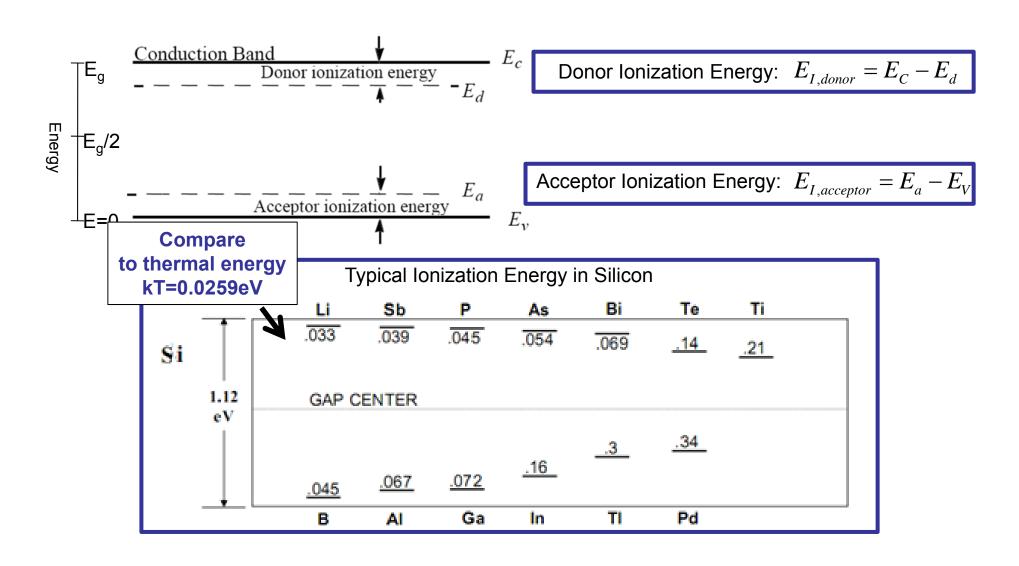
• The real numbers of donors and acceptors in Si:

Donor in Si	Р	As	Sb
Binding energy (eV)	0.045	0.054	0.039

Acceptor in Si	В	Al	Ga	In
Binding energy (eV)	0.045	0.067	0.072	0.16

(note: binding energy = ionization energy)

Typical Impurity Ionization Energy in Silicon



Question

• If use Si to replace Ga in GaAs? Is Si atom server as

donor or acceptor?

	IIIA	IVA	VA	VIA
	7	6	7	ο
	В	С	N	O
3	13	14	15	16
IIB	ΑI	Si	Р	S
30	31	32	33	34
Zn	Ga	Ge	As	Se
48	49	50	51	52
Cd	In	Sn	Sb	Te